

## Silicon Fast Recovery Diode

$V_{RRM} = 800 \text{ V - } 1000 \text{ V}$   
 $I_F = 20 \text{ A}$

### Features

- High Surge Capability
- Types up to 1000 V  $V_{RRM}$

DO-5 Package



**Maximum ratings, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified ("R" devices have leads reversed)**

Parameter	Symbol	Conditions	FR20K(R)05	FR20M(R)05	Unit
Repetitive peak reverse voltage	$V_{RRM}$		800	1000	V
RMS reverse voltage	$V_{RMS}$		560	700	V
DC blocking voltage	$V_{DC}$		800	1000	V
Continuous forward current	$I_F$	$T_C \leq 100^\circ\text{C}$	20	20	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_p = 8.3 \text{ ms}$	250	250	A
Operating temperature	$T_j$		-40 to 125	-40 to 125	$^\circ\text{C}$
Storage temperature	$T_{stg}$		-40 to 150	-40 to 150	$^\circ\text{C}$

**Electrical characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	FR20K(R)05	FR20M(R)05	Unit
Diode forward voltage	$V_F$	$I_F = 20 \text{ A}, T_j = 25^\circ\text{C}$	1.4	1.4	V
Reverse current	$I_R$	$V_R = 800 \text{ V}, T_j = 25^\circ\text{C}$ $V_R = 800 \text{ V}, T_j = 125^\circ\text{C}$	25 10	25 10	$\mu\text{A}$ mA
<b>Recovery Time</b>					
Maximum reverse recovery time	$T_{RR}$	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A},$ $I_{RR} = 0.25 \text{ A}$	500	500	nS
<b>Thermal characteristics</b>					
Thermal resistance, junction - case	$R_{thJC}$		0.6	0.6	$^\circ\text{C/W}$

